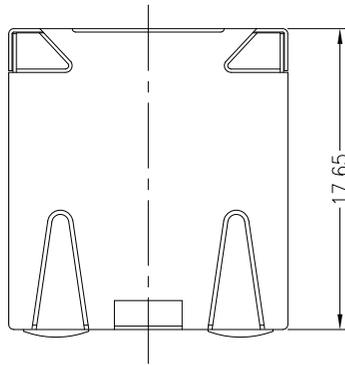


GP Component

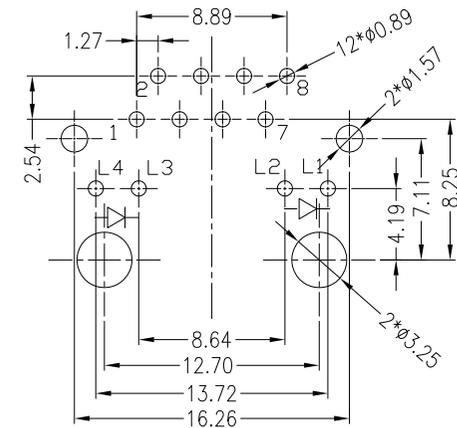
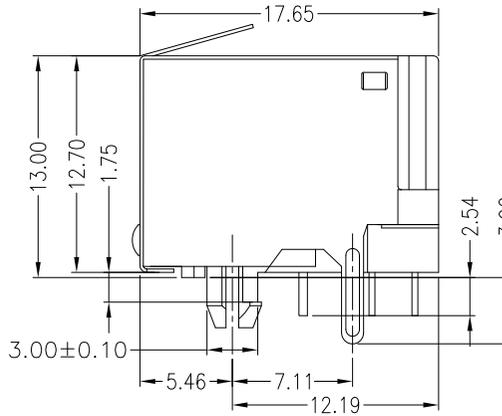
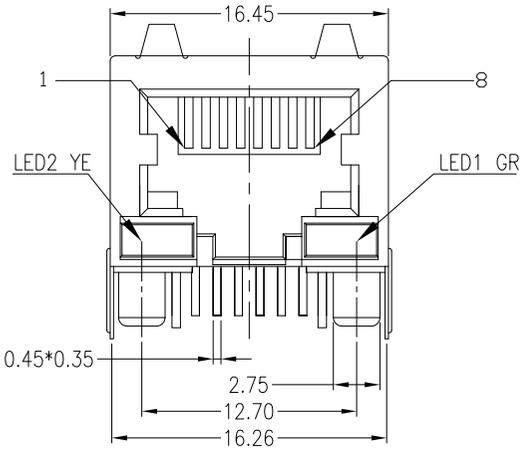
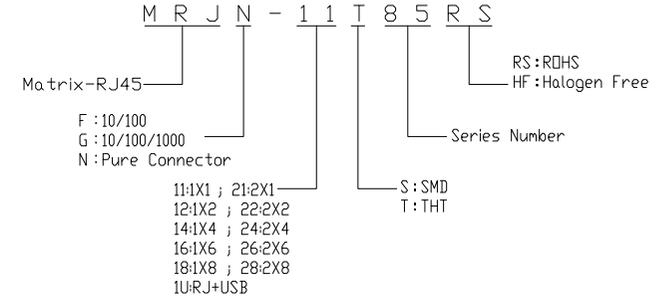
REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2013/09/13	Jamie Zie
A1			Modify	2017/01/19	Phebe Su



NOTES:

- MATERIALS:**
HOUSING: PBT BLACK(UL94V-0)
CONTACTS: PHOSPHOR BRONZE
- FINISH:**
CONTACT: 50u" NICKE LUNDERPLAT ON ALL AREA,
100u"MIN. TIN ON SOLDERTAILS,
G/F GOLD PLATED ON CONTACT AREA.
SHIELD: COPPER ALLOY PLATED WITH NICKEL
- OPERATING TEMPERATURE:** -40c ~ +85c
- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F**

MATRIX PART NO:



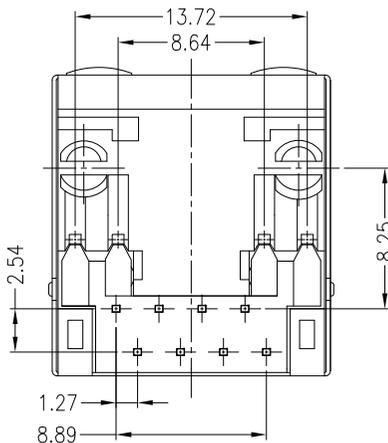
SUGGESTED PCB LAYOUT

(TOP VIEW)

DIMENSIONS TOLERANCE: .XX±0.05

LED CODE :

	Left LED2		Right LED1	
1	L4+ L3-	L4- L3+	L2+ L1-	L2- L1+
	YE		GR	



NO	VARIETY	QTY	MATERIAL	REMARK
			Matrix Electronics Co.,Ltd	
TOLERANCE: X:X ±0.38 X:XX ±0.25 X:XXX ±0.13 ANGLE: ±3°		DESIGN BY : Phebe Su	DATE : 2017/01/19	PART NAME: RJ45 CONN JM 1*1 BOTTOM CONNCTOR W/LED, 8P8C
		CHECKED BY: Vicky Hsieh	DATE : 2017/01/19	PART NO. MRJN-11T85RS
		APPROVED BY1: Richard Hsieh	DATE : 2017/01/19	MOLD NO. NA
		APPROVED BY2: Richard Hsieh	DATE : 2017/01/19	DRAW NO.
SCALE:1:1		SIZE:A4	SHEET NO.	1 OF 1